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Silicon N-Channel MOS FET



ADE-208-1293 (Z) 1st. Edition Mar. 2001

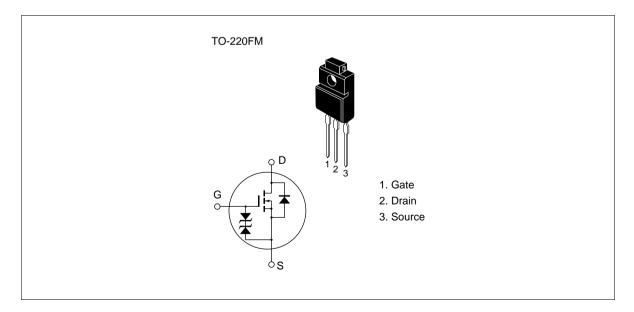
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1566	V _{DSS}	450	V
	2SK1567		500	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	7	A
Drain peak current		I*1 D(pulse)	28	A
Body to drain diode reverse	e drain current	I _{DR}	7	A
Channel dissipation		Pch*2	35	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Note 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

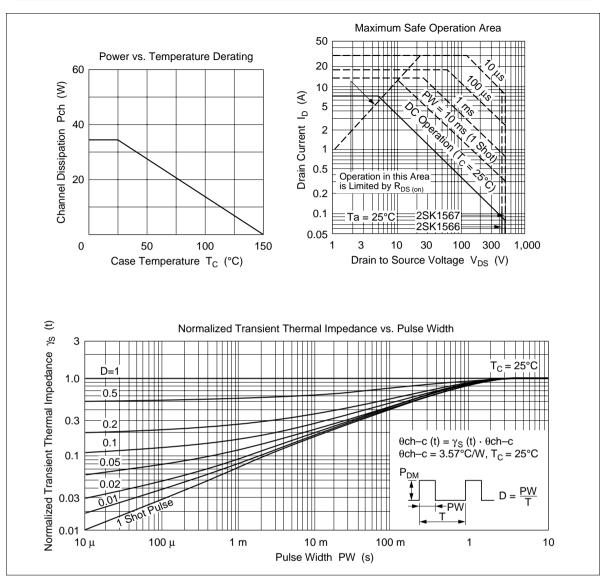
2. Value at T_c = $25^{\circ}C$

Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1566	$V_{(\text{BR})\text{DSS}}$	450	_	_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
breakdown voltage	2SK1567	-	500	_			
Gate to source break	down	$V_{(\text{BR})\text{GSS}}$	±30	—	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak c	urrent	I _{GSS}	—	_	±10	μA	$V_{GS} = \pm 25 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage	2SK1566	I _{DSS}	—	_	250	μA	$V_{\rm DS} = 360 \text{ V}, \text{ V}_{\rm GS} = 0$
drain current	2SK1567	-					$V_{\rm DS} = 400 \text{ V}, V_{\rm GS} = 0$
Gate to source cutoff	voltage	$V_{\text{GS(off)}}$	2.0	_	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static Drain to source	2SK1566		_	0.6	0.8	Ω	$I_{D} = 4 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
on state resistance	2SK1567	-	_	0.7	0.9	-	
Forward transfer adm	ittance	yfs	4.0	6.5	_	S	$I_{\rm D} = 4 \text{ A}, V_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance		Ciss	_	1050	_	pF	$V_{\rm DS} = 10 \text{ V}, \text{ V}_{\rm GS} = 0,$
Output capacitance		Coss	—	280	_	pF	f = 1 MHz
Reverse transfer capa	acitance	Crss	—	40	_	pF	
Turn-on delay time		t _{d(on)}	_	15	_	ns	$I_{\rm D} = 4$ A, $V_{\rm GS} = 10$ V,
Rise time		t,	_	55	_	ns	$R_{L} = 7.5 \Omega$
Turn-off delay time		t _{d(off)}	_	95	_	ns	
Fall time		t _f	_	40	_	ns	
Body to drain diode for voltage	orward	V_{DF}	_	0.95	—	V	$I_F = 7 \text{ A}, V_{GS} = 0$
Body to drain diode re recovery time	everse	t _{rr}	_	320	_	ns	$I_F = 7 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

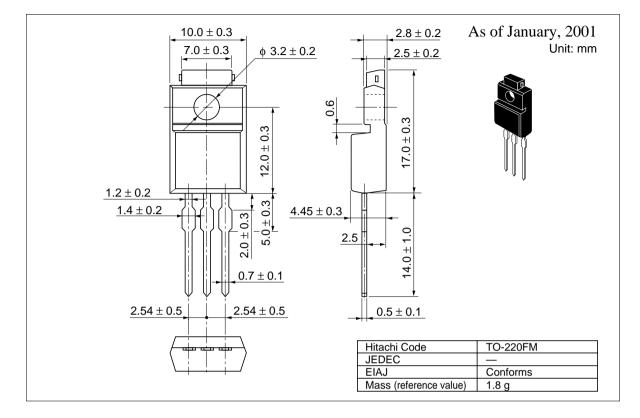
Electrical Characteristics (Ta = 25°C)

Note 1. Pulse test

See characteristic curves of 2SK1157, 2SK1158.



Package Dimensions



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